Triple low-ohmic single-pole double-throw analog switchRev. 5 — 25 June 2012Product data sheet

## 1. General description

The NX3L4053 is a triple low-ohmic single-pole double-throw analog switch, suitable for use as an analog or digital multiplexer/demultiplexer. Each switch has a digital select input (nS), two independent inputs/outputs (nY0 and nY1) and a common input/output (nZ). All three switches share an enable input ( $\overline{E}$ ). A digital enable pin  $\overline{E}$  is common to all switches.When  $\overline{E}$  is HIGH, the switches are turned off.

Schmitt trigger action at the digital inputs makes the circuit tolerant to slower input rise and fall times. Low threshold digital inputs allows this device to be driven by 1.8 V logic levels in 3.3 V applications without significant increase in supply current I<sub>CC</sub>. This makes it possible for the NX3L4053 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation. The NX3L4053 allows signals with amplitude up to V<sub>CC</sub> to be transmitted from nZ to nY0 or nY1; or from nY0 or nY1 to nZ. Its low ON resistance (0.5  $\Omega$ ) and flatness (0.13  $\Omega$ ) ensures minimal attenuation and distortion of transmitted signals.

## 2. Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance (peak):
  - 1.8  $\Omega$  (typical) at V<sub>CC</sub> = 1.4 V
  - 1.0  $\Omega$  (typical) at V<sub>CC</sub> = 1.65 V
  - 0.6  $\Omega$  (typical) at V<sub>CC</sub> = 2.3 V
  - 0.6  $\Omega$  (typical) at V<sub>CC</sub> = 2.7 V
  - 0.5  $\Omega$  (typical) at V<sub>CC</sub> = 4.3 V
- Break-before-make switching
- High noise immunity
- ESD protection:
  - HBM JESD22-A114F Class 3A exceeds 4000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM AEC-Q100-011 revision B exceeds 1000 V
  - ◆ IEC61000-4-2 contact discharge exceeds 6000 V for switch ports
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level A
- 1.8 V control logic at V<sub>CC</sub> = 3.6 V
- Control input accepts voltages above supply voltage
- Very low supply current, even when input is below V<sub>CC</sub>
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from –40 °C to +85 °C and from –40 °C to +125 °C



### Triple low-ohmic single-pole double-throw analog switch

# 3. Applications

- Cell phone
- PDA
- Portable media player
- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating

# 4. Ordering information

 Table 1.
 Ordering information

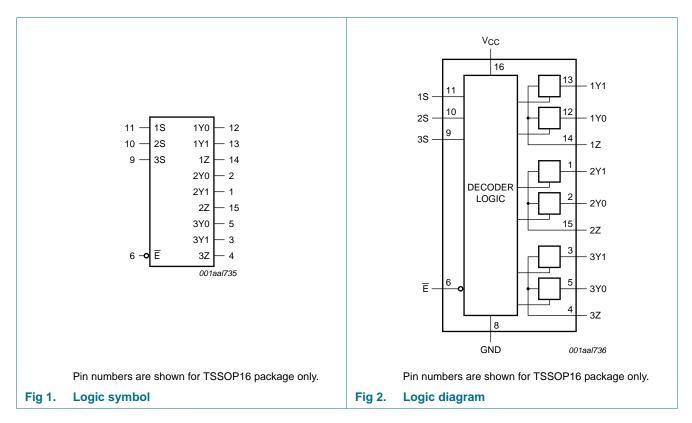
| Type number | Package           | Package |  |           |  |  |  |  |  |  |  |
|-------------|-------------------|---------|--|-----------|--|--|--|--|--|--|--|
|             | Temperature range | Name    | Description  | Version   |  |  |  |  |  |  |  |
| NX3L4053HR  | –40 °C to +125 °C | HXQFN16 | plastic thermal enhanced extremely thin quad flat package; no leads; 16 terminals; body $3 \times 3 \times 0.5$ mm | SOT1039-2 |  |  |  |  |  |  |  |
| NX3L4053PW  | –40 °C to +125 °C | TSSOP16 | plastic thin shrink small outline package; 16 leads;<br>body width 4.4 mm  | SOT403-1  |  |  |  |  |  |  |  |

# 5. Marking

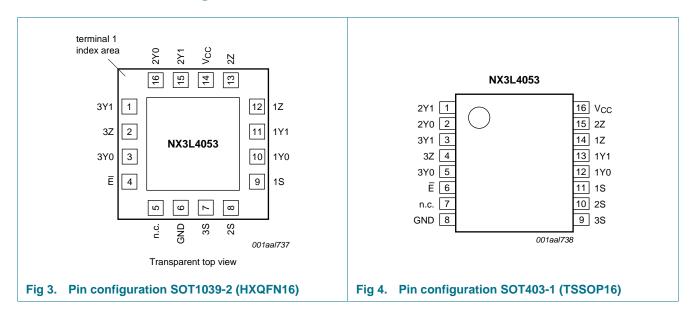
| Table 2. Marking codes |              |
|------------------------|--------------|
| Type number            | Marking code |
| NX3L4053HR             | M43          |
| NX3L4053PW             | X3L4053      |

Triple low-ohmic single-pole double-throw analog switch

# 6. Functional diagram



# 7. Pinning information



## 7.1 Pinning

### Triple low-ohmic single-pole double-throw analog switch

## 7.2 Pin description

. ..

| Symbol          | Pin       |           | Description                 |
|-----------------|-----------|-----------|-----------------------------|
|                 | SOT1039-2 | SOT403-1  |                             |
| Ē               | 4         | 6         | enable input (active LOW)   |
| n.c.            | 5         | 7         | not connected               |
| GND             | 6         | 8         | ground (0 V)                |
| 1S, 2S, 3S      | 9, 8, 7   | 11, 10 ,9 | select input                |
| 1Y0, 2Y0, 3Y0   | 10, 16, 3 | 12, 2, 5  | independent input or output |
| 1Y1, 2Y1, 3Y1   | 11, 15, 1 | 13, 1, 3  | independent input or output |
| 1Z , 2Z, 3Z     | 12, 13, 2 | 14, 15, 4 | independent output or input |
| V <sub>CC</sub> | 14        | 16        | supply voltage              |

# 8. Functional description

| Table 4. | Function table |            |              |
|----------|----------------|------------|--------------|
| Inputs   |                | Channel on |              |
| E        |                | nS         | -            |
| L        |                | L          | nY0 to nZ    |
| L        |                | Н          | nY1 to nZ    |
| Н        |                | Х          | switches off |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

## 9. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions   | Min             | Max                   | Unit |
|------------------|-------------------------|--|-----------------|-----------------------|------|
| V <sub>CC</sub>  | supply voltage          |  | -0.5            | +4.6                  | V    |
| VI               | input voltage           | nS and E   | <u>[1]</u> –0.5 | +4.6                  | V    |
| V <sub>SW</sub>  | switch voltage          |  | 2 -0.5          | V <sub>CC</sub> + 0.5 | V    |
| I <sub>IK</sub>  | input clamping current  | $V_{I} < -0.5 V$   | -50             | -                     | mA   |
| I <sub>SK</sub>  | switch clamping current | $V_{\rm I}$ < -0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V   | -               | ±50                   | mA   |
| I <sub>SW</sub>  | switch current          | $V_{SW}$ > -0.5 V or $V_{SW}$ < $V_{CC}$ + 0.5 V;<br>source or sink current                                      | -               | ±350                  | mA   |
|                  |                         | $V_{SW}$ > -0.5 V or $V_{SW}$ < $V_{CC}$ + 0.5 V;<br>pulsed at 1 ms duration, < 10 % duty cycle;<br>peak current | -               | ±500                  | mA   |
| T <sub>stg</sub> | storage temperature     |  | -65             | +150                  | °C   |
| P <sub>tot</sub> | total power dissipation | $T_{amb} = -40 \text{ °C to } +125 \text{ °C}$   |                 |                       |      |
|                  |                         | HXQFN16  | [3]             | 250                   | mW   |
|                  |                         | TSSOP16  | <u>[4]</u> _    | 500                   | mW   |

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

# NX3L4053

#### Triple low-ohmic single-pole double-throw analog switch

- [2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.
- [3] For HXQFN16 package: above 135 °C the value of Ptot derates linearly with 16.9 mW/K.
- [4] For TSSOP16 package: above 60 °C the value of P<sub>tot</sub> derates linearly with 5.5 mW/K.

# **10.** Recommended operating conditions

#### Table 6. Recommended operating conditions

| Symbol                | Parameter                           | Conditions   | Min          | Max             | Unit |
|-----------------------|-------------------------------------|--|--------------|-----------------|------|
| V <sub>CC</sub>       | supply voltage                      |  | 1.4          | 4.3             | V    |
| VI                    | input voltage                       | nS and $\overline{E}$                                    | 0            | 4.3             | V    |
| V <sub>SW</sub>       | switch voltage                      |  | <u>[1]</u> 0 | V <sub>CC</sub> | V    |
| T <sub>amb</sub>      | ambient temperature                 |  | -40          | +125            | °C   |
| $\Delta t / \Delta V$ | input transition rise and fall rate | nS and $\overline{E}$ ; V <sub>CC</sub> = 1.4 V to 4.3 V | -            | 200             | ns/V |

[1] To avoid sinking GND current from terminal nZ when switch current flows in terminal nYn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no GND current will flow from terminal nYn. In this case, there is no limit for the voltage drop across the switch.

# **11. Static characteristics**

#### Table 7.Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

| Symbol              | Parameter                                   | Conditions  | Ta  | <sub>mb</sub> = 25 | °C  | T <sub>amb</sub> = | –40 °C to      | +125 °C         | Unit |
|---------------------|---|---|-----|--------------------|-----|--------------------|----------------|-----------------|------|
|                     |   |   | Min | Тур                | Max | Min                | Max<br>(85 °C) | Max<br>(125 °C) |      |
| V <sub>IH</sub>     | / <sub>IH</sub> HIGH-level<br>input voltage | $V_{CC}$ = 1.4 V to 1.6 V   | 0.9 | -                  | -   | 0.9                | -              | -               | V    |
|                     |   | $V_{CC}$ = 1.65 V to 1.95 V   | 0.9 | -                  | -   | 0.9                | -              | -               | V    |
|                     |   | $V_{CC}$ = 2.3 V to 2.7 V   | 1.1 | -                  | -   | 1.1                | -              | -               | V    |
|                     |   | $V_{CC}$ = 2.7 V to 3.6 V   | 1.3 | -                  | -   | 1.3                | -              | -               | V    |
|                     |   | $V_{CC}$ = 3.6 V to 4.3 V   | 1.4 | -                  | -   | 1.4                | -              | -               | V    |
| VIL                 | LOW-level                                   | $V_{CC}$ = 1.4 V to 1.6 V   | -   | -                  | 0.3 | -                  | 0.3            | 0.3             | V    |
|                     | input voltage                               | $V_{CC}$ = 1.65 V to 1.95 V   | -   | -                  | 0.4 | -                  | 0.4            | 0.3             | V    |
|                     |   | $V_{CC}$ = 2.3 V to 2.7 V   | -   | -                  | 0.4 | -                  | 0.4            | 0.4             | V    |
|                     |   | $V_{CC}$ = 2.7 V to 3.6 V   | -   | -                  | 0.5 | -                  | 0.5            | 0.5             | V    |
|                     |   | $V_{CC}$ = 3.6 V to 4.3 V   | -   | -                  | 0.6 | -                  | 0.6            | 0.6             | V    |
| I                   | input leakage<br>current                    | nS and $\overline{E}$ ;<br>V <sub>I</sub> = GND to 4.3 V;<br>V <sub>CC</sub> = 1.4 V to 4.3 V | -   | -                  | -   | -                  | ±0.5           | ±1              | μΑ   |
| I <sub>S(OFF)</sub> | OFF-state<br>leakage                        | nY0 and nY1 port;<br>see <mark>Figure 5</mark>  |     |                    |     |                    |                |                 |      |
|                     | current                                     | $V_{CC}$ = 1.4 V to 3.6 V   | -   | -                  | ±5  | -                  | ±50            | ±500            | nA   |
|                     |   | $V_{CC} = 3.6 \text{ V} \text{ to } 4.3 \text{ V}$  | -   | -                  | ±10 | -                  | ±50            | ±500            | nA   |

# NX3L4053

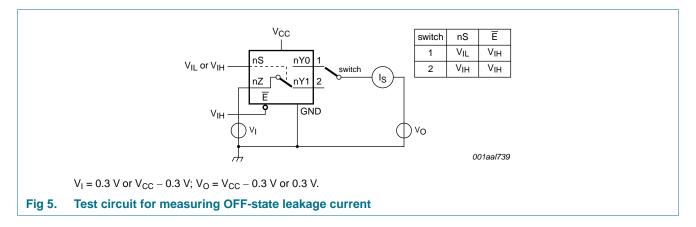
#### Triple low-ohmic single-pole double-throw analog switch

### Table 7. Static characteristics ...continued

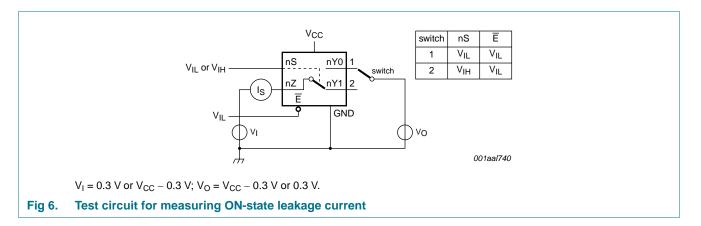
At recommended operating conditions; voltages are referenced to GND (ground 0 V).

| Symbol                         | Parameter   | Conditions  | Τ <sub>έ</sub> | amb = 25 | °C   | T <sub>amb</sub> = | –40 °C to      | +125 °C         | Unit |
|--------------------------------|---|---|----------------|----------|------|--------------------|----------------|-----------------|------|
|                                |   |   | Min            | Тур      | Мах  | Min                | Max<br>(85 °C) | Max<br>(125 °C) |      |
| leakag                         | ON-state<br>leakage<br>current  | nZ port;<br>$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V};$<br>see Figure 6 |                |          |      |                    |                |                 |      |
|                                |   | $V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$                              | -              | -        | ±5   | -                  | ±50            | ±500            | nA   |
|                                |   | $V_{CC} = 3.6 V \text{ to } 4.3 V$                                      | -              | -        | ±10  | -                  | ±50            | ±500            | nA   |
| I <sub>CC</sub> supply current | $V_{I} = V_{CC} \text{ or GND};$<br>$V_{SW} = GND \text{ or } V_{CC}$ |   |                |          |      |                    |                |                 |      |
|                                |   | V <sub>CC</sub> = 3.6 V   | -              | -        | 100  | -                  | 500            | 5000            | nA   |
|                                |   | $V_{CC} = 4.3 V$  | -              | -        | 150  | -                  | 800            | 6000            | nA   |
| $\Delta I_{CC}$                | additional  | $V_{SW}$ = GND or $V_{CC}$  |                |          |      |                    |                |                 |      |
|                                | supply current  | $V_{I} = 2.6 \text{ V}; V_{CC} = 4.3 \text{ V}$                         | -              | 2.0      | 4.0  | -                  | 7              | 7               | μA   |
|                                |   | $V_{I} = 2.6 \text{ V}; V_{CC} = 3.6 \text{ V}$                         | -              | 0.35     | 0.7  | -                  | 1              | 1               | μA   |
|                                |   | $V_{I} = 1.8 \text{ V}; V_{CC} = 4.3 \text{ V}$                         | -              | 7.0      | 10.0 | -                  | 15             | 15              | μA   |
|                                |   | $V_{I} = 1.8 \text{ V}; V_{CC} = 3.6 \text{ V}$                         | -              | 2.5      | 4.0  | -                  | 5              | 5               | μA   |
|                                |   | $V_{I} = 1.8 \text{ V}; V_{CC} = 2.5 \text{ V}$                         | -              | 50       | 200  | -                  | 300            | 500             | nA   |
| CI                             | input<br>capacitance  | nS and $\overline{E}$   | -              | 1.0      | -    | -                  | -              | -               | pF   |
| $C_{S(OFF)}$                   | OFF-state capacitance   |   | -              | 35       | -    | -                  | -              | -               | pF   |
| $C_{S(ON)}$                    | ON-state capacitance  |   | -              | 130      | -    | -                  | -              | -               | pF   |

## 11.1 Test circuits



#### Triple low-ohmic single-pole double-throw analog switch



## 11.2 ON resistance

#### Table 8. ON resistance<sup>[1]</sup>

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 8 to Figure 14.

| Symbol                | Parameter                   | Conditions  | T <sub>amb</sub> = | -40 °C to          | o +85 °C | $T_{amb} = -40 \circ$ | C to +125 °C | Unit |
|-----------------------|-----------------------------|---|--------------------|--------------------|----------|-----------------------|--------------|------|
|                       |                             |   | Min                | Typ <sup>[2]</sup> | Max      | Min                   | Max          |      |
| R <sub>ON(peak)</sub> | ON resistance<br>(peak)     | $V_I = GND$ to $V_{CC}$ ;<br>$I_{SW} = 100$ mA; see <u>Figure 7</u> |                    |                    |          |                       |              |      |
|                       |                             | $V_{CC} = 1.4 V$  | -                  | 1.8                | 3.8      | -                     | 4.2          | Ω    |
|                       |                             | V <sub>CC</sub> = 1.65 V  | -                  | 1.0                | 1.7      | -                     | 1.8          | Ω    |
|                       |                             | $V_{CC} = 2.3 V$  | -                  | 0.6                | 0.9      | -                     | 1.0          | Ω    |
|                       |                             | $V_{CC} = 2.7 V$  | -                  | 0.6                | 0.80     | -                     | 1.0          | Ω    |
|                       |                             | $V_{CC} = 4.3 V$  | -                  | 0.5                | 0.80     | -                     | 1.0          | Ω    |
| $\Delta R_{ON}$       | ON resistance mismatch      | $V_I = GND \text{ to } V_{CC};$<br>$I_{SW} = 100 \text{ mA}$        | <u>3]</u>          |                    |          |                       |              |      |
|                       | between<br>channels         | $V_{CC}$ = 1.4 V; $V_{SW}$ = 0.4 V                                  | -                  | 0.23               | 0.38     | -                     | 0.38         | Ω    |
|                       | Channels                    | $V_{CC}$ = 1.65 V; $V_{SW}$ = 0.5 V                                 | -                  | 0.23               | 0.28     | -                     | 0.38         | Ω    |
|                       |                             | $V_{CC}$ = 2.3 V; $V_{SW}$ = 0.7 V                                  | -                  | 0.12               | 0.15     | -                     | 0.18         | Ω    |
|                       |                             | $V_{CC} = 2.7 \text{ V}; V_{SW} = 0.8 \text{ V}$                    | -                  | 0.12               | 0.15     | -                     | 0.18         | Ω    |
|                       |                             | $V_{CC}$ = 4.3 V; $V_{SW}$ = 0.8 V                                  | -                  | 0.12               | 0.15     | -                     | 0.18         | Ω    |
| R <sub>ON(flat)</sub> | ON resistance<br>(flatness) | $V_{I} = GND \text{ to } V_{CC};$<br>$I_{SW} = 100 \text{ mA}$      | 4]                 |                    |          |                       |              |      |
|                       |                             | $V_{CC} = 1.4 V$  | -                  | 1.0                | 3.3      | -                     | 3.6          | Ω    |
|                       |                             | V <sub>CC</sub> = 1.65 V  | -                  | 0.5                | 1.2      | -                     | 1.3          | Ω    |
|                       |                             | $V_{CC} = 2.3 V$  | -                  | 0.15               | 0.3      | -                     | 0.35         | Ω    |
|                       |                             | $V_{CC} = 2.7 V$  | -                  | 0.13               | 0.3      | -                     | 0.35         | Ω    |
|                       |                             | $V_{CC} = 4.3 V$  | -                  | 0.2                | 0.4      | -                     | 0.45         | Ω    |

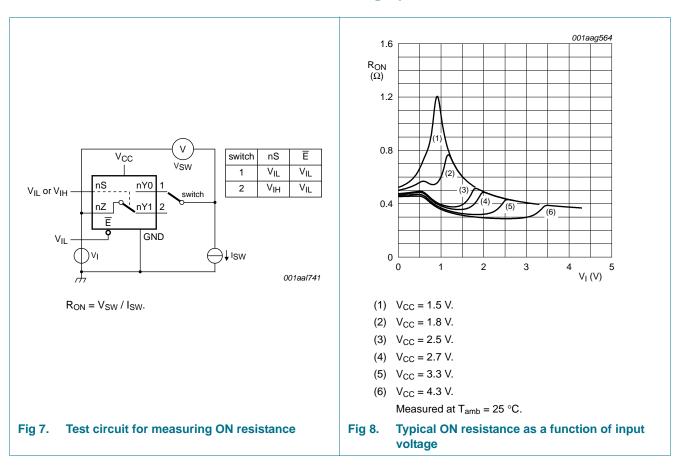
[1] For NX3L4053PW (TSSOP16 package), all ON resistance values are up to 0.05  $\Omega$  higher.

[2] Typical values are measured at  $T_{amb} = 25 \ ^{\circ}C$ .

[3] Measured at identical V<sub>CC</sub>, temperature and input voltage.

[4] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V<sub>CC</sub> and temperature.

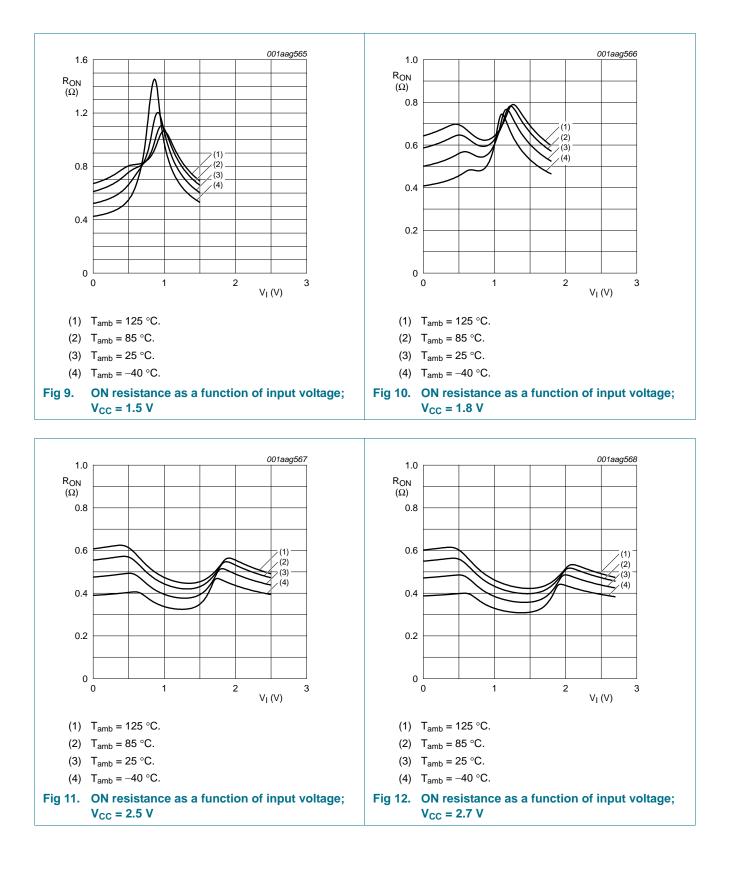
Triple low-ohmic single-pole double-throw analog switch



## 11.3 ON resistance test circuit and graphs

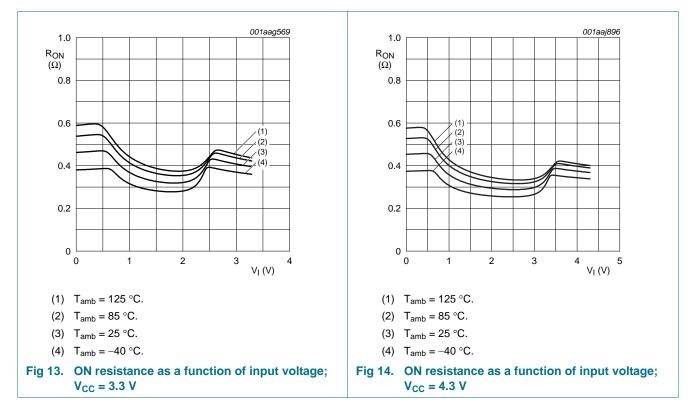
# NX3L4053

#### Triple low-ohmic single-pole double-throw analog switch



# NX3L4053

#### Triple low-ohmic single-pole double-throw analog switch



## 12. Dynamic characteristics

#### Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 17.

| Symbol           | Parameter    | Conditions                                  | Ta  | <sub>mb</sub> = 25   | °C  | T <sub>amb</sub> = | –40 °C to      | +125 °C         | Unit |
|------------------|--------------|---|-----|----------------------|-----|--------------------|----------------|-----------------|------|
|                  |              |   | Min | Typ <mark>[1]</mark> | Мах | Min                | Мах<br>(85 °С) | Max<br>(125 °C) |      |
| t <sub>en</sub>  | enable time  | Ē, nS to nZ or nYn;<br>see <u>Figure 15</u> |     |                      |     |                    |                |                 |      |
|                  |              | $V_{CC}$ = 1.4 V to 1.6 V                   | -   | 49                   | 90  | -                  | 120            | 120             | ns   |
|                  |              | V <sub>CC</sub> = 1.65 V to 1.95 V          | -   | 35                   | 70  | -                  | 80             | 90              | ns   |
|                  |              | $V_{CC}$ = 2.3 V to 2.7 V                   | -   | 23                   | 45  | -                  | 50             | 55              | ns   |
|                  |              | $V_{CC}$ = 2.7 V to 3.6 V                   | -   | 21                   | 40  | -                  | 45             | 50              | ns   |
|                  |              | $V_{CC}$ = 3.6 V to 4.3 V                   | -   | 21                   | 40  | -                  | 45             | 50              | ns   |
| t <sub>dis</sub> | disable time | Ē, nS to nZ or nYn;<br>see <u>Figure 15</u> |     |                      |     |                    |                |                 |      |
|                  |              | $V_{CC}$ = 1.4 V to 1.6 V                   | -   | 32                   | 70  | -                  | 80             | 90              | ns   |
|                  |              | $V_{CC}$ = 1.65 V to 1.95 V                 | -   | 17                   | 55  | -                  | 60             | 65              | ns   |
|                  |              | $V_{CC}$ = 2.3 V to 2.7 V                   | -   | 11                   | 25  | -                  | 30             | 35              | ns   |
|                  |              | $V_{CC}$ = 2.7 V to 3.6 V                   | -   | 8                    | 20  | -                  | 25             | 30              | ns   |
|                  |              | $V_{CC}$ = 3.6 V to 4.3 V                   | -   | 8                    | 20  | -                  | 25             | 30              | ns   |

#### Triple low-ohmic single-pole double-throw analog switch

| Symbol           | Parameter         | Conditions   |     | Ta  | <sub>mb</sub> = 25   | °C  | T <sub>amb</sub> = | –40 °C to      | +125 °C         | Unit |
|------------------|-------------------|--|-----|-----|----------------------|-----|--------------------|----------------|-----------------|------|
|                  |                   |  |     | Min | Typ <mark>[1]</mark> | Max | Min                | Max<br>(85 °C) | Max<br>(125 °C) |      |
| t <sub>b-m</sub> | break-before-make | see Figure 16  | [2] |     |                      |     |                    | •              |                 |      |
|                  | time              | $V_{CC} = 1.4 \text{ V}$ to 1.6 V                    |     | -   | 19                   | -   | 9                  | -              | -               | ns   |
|                  |                   | $V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$ |     | -   | 17                   | -   | 7                  | -              | -               | ns   |
|                  |                   | $V_{CC}$ = 2.3 V to 2.7 V                            |     | -   | 13                   | -   | 4                  | -              | -               | ns   |
|                  |                   | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$           |     | -   | 10                   | -   | 3                  | -              | -               | ns   |
|                  |                   | $V_{CC}$ = 3.6 V to 4.3 V                            |     | -   | 9                    | -   | 2                  | -              | -               | ns   |

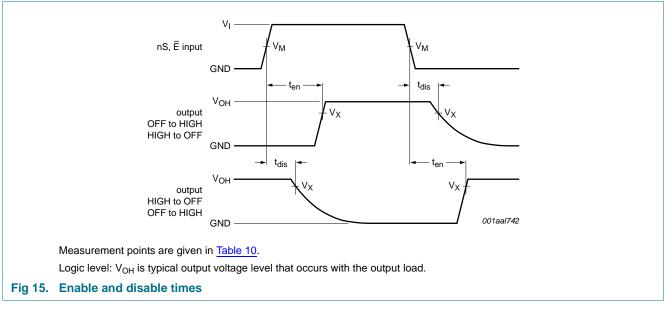
#### Table 9. Dynamic characteristics ... continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 17.

[1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

[2] Break-before-make guaranteed by design.

## 12.1 Waveform and test circuits

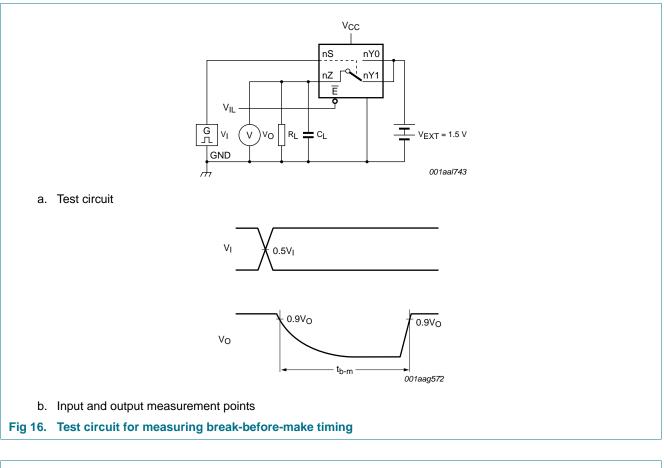


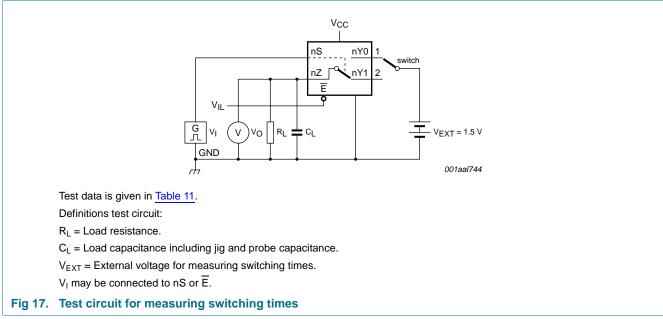
#### Table 10. Measurement points

| Supply voltage  | Input              | Output             |
|-----------------|--------------------|--------------------|
| V <sub>cc</sub> | V <sub>M</sub>     | V <sub>X</sub>     |
| 1.4 V to 4.3 V  | 0.5V <sub>CC</sub> | 0.9V <sub>OH</sub> |

# NX3L4053

#### Triple low-ohmic single-pole double-throw analog switch





#### Triple low-ohmic single-pole double-throw analog switch

#### Table 11.Test data

| Supply voltage  | Input           |                                 | Load  |                |
|-----------------|-----------------|---------------------------------|-------|----------------|
| V <sub>cc</sub> | VI              | t <sub>r</sub> , t <sub>f</sub> | CL    | R <sub>L</sub> |
| 1.4 V to 4.3 V  | V <sub>CC</sub> | ≤ 2.5 ns                        | 35 pF | 50 Ω           |

## 12.2 Additional dynamic characteristics

### Table 12. Additional dynamic characteristics

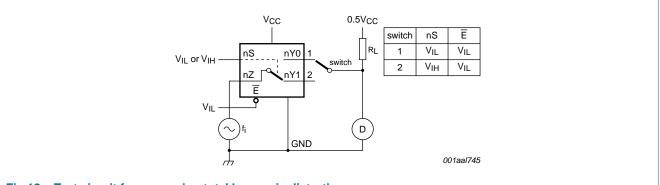
At recommended operating conditions; voltages are referenced to GND (ground = 0 V);  $V_I = GND$  or  $V_{CC}$  (unless otherwise specified);  $t_r = t_f \le 2.5$  ns;  $T_{amb} = 25$  °C.

| Symbol                | Parameter                    | Conditions   | Min        | Тур  | Max | Unit |
|-----------------------|------------------------------|--|------------|------|-----|------|
| THD                   | total harmonic<br>distortion | $f_i = 20 \text{ Hz to } 20 \text{ kHz}; \text{ R}_L = 32 \Omega; \text{ see } \frac{\text{Figure } 18}{1000 \text{ sec } 18}$                           | <u>[1]</u> |      |     |      |
|                       |                              | V <sub>CC</sub> = 1.4 V; V <sub>I</sub> = 1 V (p-p)  | -          | 0.15 | -   | %    |
|                       |                              | V <sub>CC</sub> = 1.65 V; V <sub>I</sub> = 1.2 V (p-p)   | -          | 0.10 | -   | %    |
|                       |                              | V <sub>CC</sub> = 2.3 V; V <sub>I</sub> = 1.5 V (p-p)  | -          | 0.02 | -   | %    |
|                       |                              | V <sub>CC</sub> = 2.7 V; V <sub>I</sub> = 2 V (p-p)  | -          | 0.02 | -   | %    |
|                       |                              | $V_{CC} = 4.3 \text{ V}; \text{ V}_{I} = 2 \text{ V} (p-p)$  | -          | 0.02 | -   | %    |
| f <sub>(-3dB)</sub>   | -3 dB frequency              | $R_L = 50 \Omega$ ; see Figure 19  | <u>[1]</u> |      |     |      |
| ( )                   | response                     | $V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$   | -          | 60   | -   | MHz  |
| $\alpha_{\text{iso}}$ | isolation (OFF-state)        | $f_i = 100 \text{ kHz}; R_L = 50 \Omega; \text{ see } \frac{\text{Figure 20}}{100 \text{ kHz}}$  | <u>[1]</u> |      |     |      |
|                       |                              | $V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$   | -          | -90  | -   | dB   |
| V <sub>ct</sub>       | crosstalk voltage            | between digital inputs and switch;<br>$f_i = 1 \text{ MHz}$ ; $C_L = 50 \text{ pF}$ ; $R_L = 50 \Omega$ ; see Figure 21                                  |            |      |     |      |
|                       |                              | $V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$   | -          | 0.2  | -   | V    |
|                       |                              | $V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$   | -          | 0.3  | -   | V    |
| Xtalk                 | crosstalk                    | between switches;<br>$f_i = 100 \text{ kHz}$ ; $R_L = 50 \Omega$ ; see Figure 22   | <u>[1]</u> |      |     |      |
|                       |                              | $V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$   | -          | -90  | -   | dB   |
| Q <sub>inj</sub>      | charge injection             | $f_i = 1 \text{ MHz}; C_L = 0.1 \text{ nF}; R_L = 1 \text{ M}\Omega; V_{gen} = 0 \text{ V}; R_{gen} = 0 \Omega; \text{ see } \frac{\text{Figure 23}}{2}$ |            |      |     |      |
|                       |                              | V <sub>CC</sub> = 1.5 V  | -          | 3    | -   | рС   |
|                       |                              | V <sub>CC</sub> = 1.8 V  | -          | 4    | -   | рС   |
|                       |                              | $V_{CC} = 2.5 V$   | -          | 6    | -   | рС   |
|                       |                              | $V_{CC} = 3.3 V$   | -          | 9    | -   | рС   |
|                       |                              | $V_{CC} = 4.3 V$   | -          | 15   | -   | рС   |

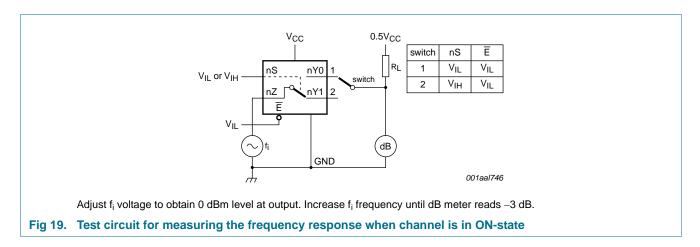
[1]  $f_i$  is biased at 0.5V<sub>CC</sub>.

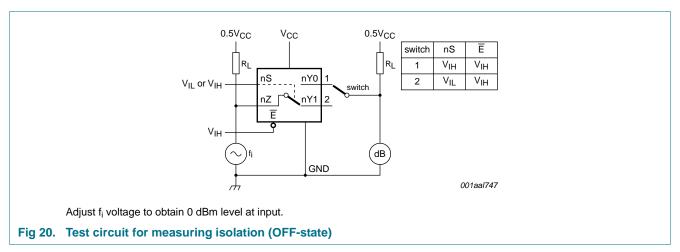
#### Triple low-ohmic single-pole double-throw analog switch

## 12.3 Test circuits

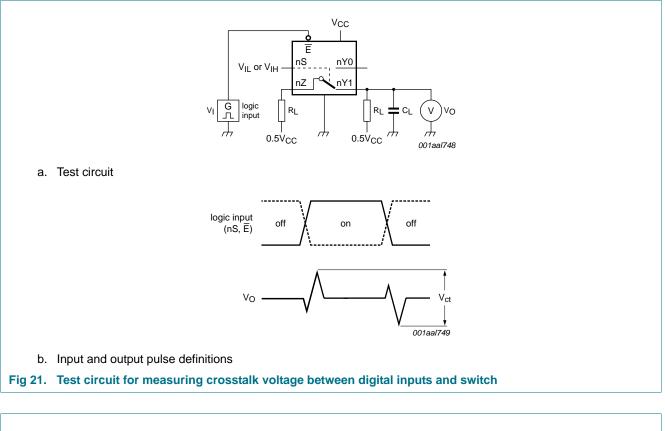


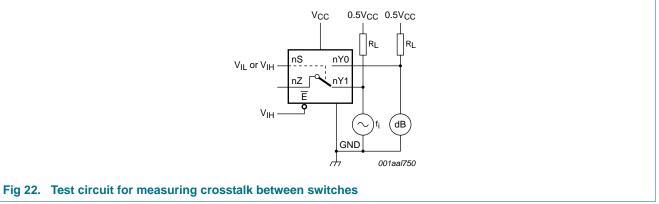
### Fig 18. Test circuit for measuring total harmonic distortion





#### Triple low-ohmic single-pole double-throw analog switch

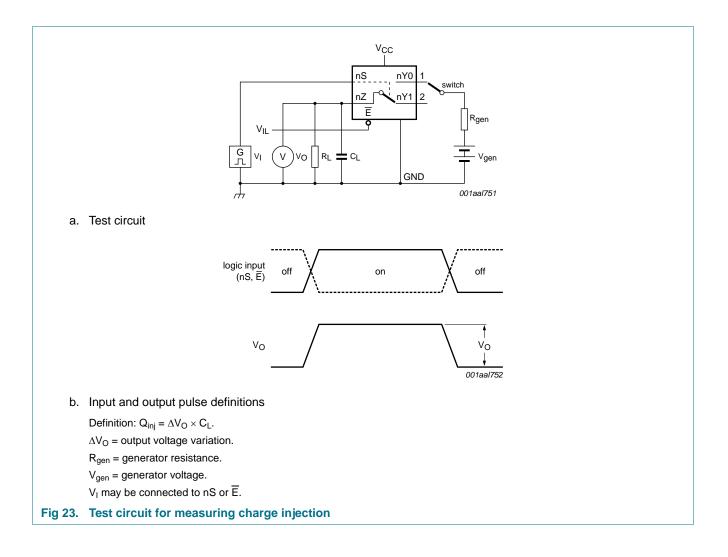




15 of 22

# NX3L4053

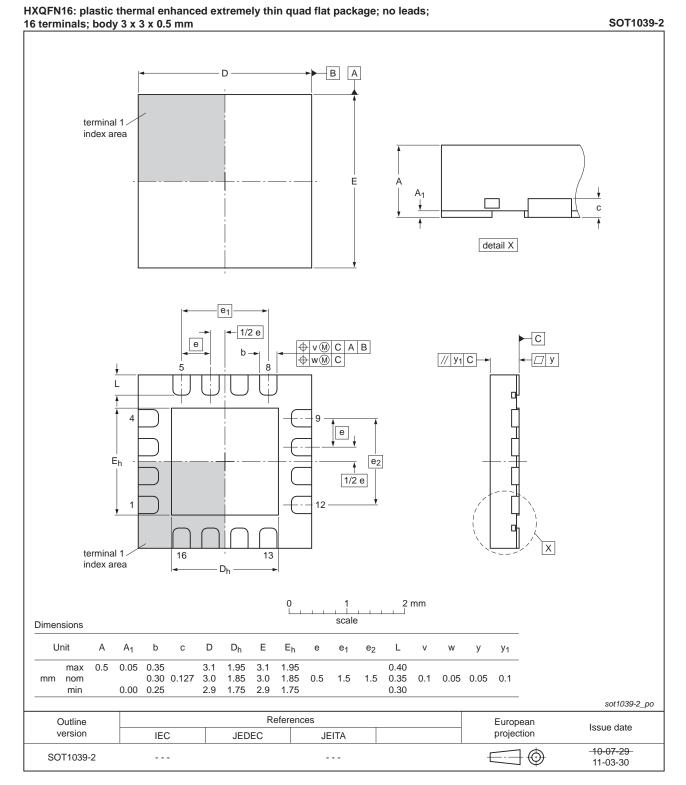
### Triple low-ohmic single-pole double-throw analog switch



# NX3L4053

Triple low-ohmic single-pole double-throw analog switch

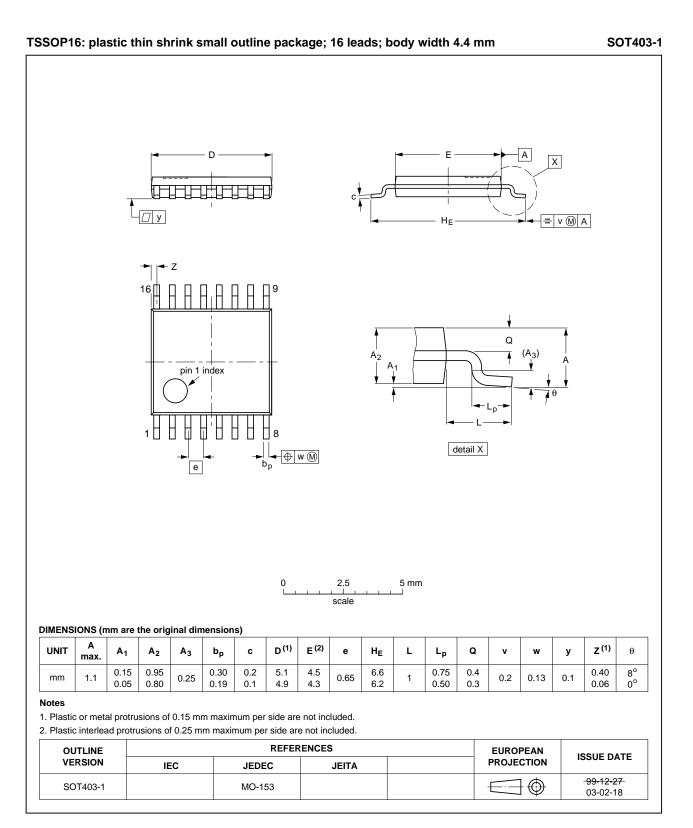
# 13. Package outline



### Fig 24. Package outline SOT1039-2 (HXQFN16)

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#### Fig 25. Package outline SOT403-1 (TSSOP16)

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Triple low-ohmic single-pole double-throw analog switch

# 14. Abbreviations

| Table 13. Abbreviations |   |  |  |  |
|-------------------------|---|--|--|--|
| Acronym                 | Description                             |  |  |  |
| CDM                     | Charged Device Model                    |  |  |  |
| CMOS                    | Complementary Metal-Oxide Semiconductor |  |  |  |
| ESD                     | ElectroStatic Discharge                 |  |  |  |
| HBM                     | Human Body Model                        |  |  |  |
| MM                      | Machine Model                           |  |  |  |
| PDA                     | Personal Digital Assistant              |  |  |  |

# 15. Revision history

| Table 14. Revision | n history                       |                         |                       |              |
|--------------------|---------------------------------|-------------------------|-----------------------|--------------|
| Document ID        | Release date                    | Data sheet status       | Change notice         | Supersedes   |
| NX3L4053 v.5       | 20120625                        | Product data sheet      | -                     | NX3L4053 v.4 |
| Modifications:     | <ul> <li>For type nu</li> </ul> | mber NX3L4053HR the sot | code has changed to S | OT1039-2.    |
| NX3L4053 v.4       | 20111107                        | Product data sheet      | -                     | NX3L4053 v.3 |
| Modifications:     | <ul> <li>Legal page</li> </ul>  | s updated.              |                       |              |
| NX3L4053 v.3       | 20101223                        | Product data sheet      | -                     | NX3L4053 v.2 |
| NX3L4053 v.2       | 20100811                        | Product data sheet      | -                     | NX3L4053 v.1 |
| NX3L4053 v.1       | 20100416                        | Product data sheet      | -                     | -            |
|                    |                                 |                         |                       |              |

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| Document status[1][2]          | Product status <sup>[3]</sup> | Definition  |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet   | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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#### Triple low-ohmic single-pole double-throw analog switch

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21 of 22

# NX3L4053

Triple low-ohmic single-pole double-throw analog switch

## **18. Contents**

| 1    | General description                   | . 1  |
|------|---------------------------------------|------|
| 2    | Features and benefits                 | . 1  |
| 3    | Applications                          | . 2  |
| 4    | Ordering information                  | . 2  |
| 5    | Marking                               | . 2  |
| 6    | Functional diagram                    | . 3  |
| 7    | Pinning information                   | . 3  |
| 7.1  | Pinning                               | . 3  |
| 7.2  | Pin description                       | . 4  |
| 8    | Functional description                | . 4  |
| 9    | Limiting values                       | . 4  |
| 10   | Recommended operating conditions      | . 5  |
| 11   | Static characteristics                | . 5  |
| 11.1 | Test circuits                         | . 6  |
| 11.2 | ON resistance                         |      |
| 11.3 | ON resistance test circuit and graphs | . 8  |
| 12   | Dynamic characteristics               | 10   |
| 12.1 | Waveform and test circuits            |      |
| 12.2 | Additional dynamic characteristics    |      |
| 12.3 | Test circuits                         | 14   |
| 13   | Package outline                       | . 17 |
| 14   | Abbreviations                         | . 19 |
| 15   | Revision history                      | . 19 |
| 16   | Legal information                     | 20   |
| 16.1 | Data sheet status                     | 20   |
| 16.2 | Definitions                           |      |
| 16.3 | Disclaimers                           | 20   |
| 16.4 | Trademarks                            | 21   |
| 17   | Contact information                   | 21   |
| 18   | Contents                              | 22   |
|      |                                       |      |

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